



P-Channel 80 V (D-S) MOSFET

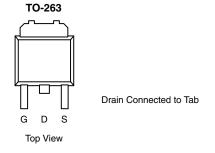
PRODUCT SUMMARY							
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A) ^b	Q _g (Typ)				
- 80	0.0112 at V _{GS} = - 10 V	- 110	85 nC				
- 80	0.0145 at V _{GS} = - 4.5 V	- 109	00 110				

FEATURES

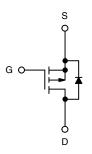
TrenchFET® Power MOSFET



Material categorization: For definitions of compliance please see www.vishav.com/doc?99912



Ordering Information: SUM110P08-11L-E3 (Lead (Pb)-free)



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	$(T_A = 25 ^{\circ}C, \text{ unle})$	ess otherwise n	oted)	
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	- 80	V	
Gate-Source Voltage	V _{GS}	± 20	V	
	T _C = 25 °C		- 110 ^a	
Continuous Drain Current (T = 175 °C)	T _C = 125 °C	l , [- 71	
Continuous Drain Current (T _J = 175 °C)	T _A = 25 °C	l _D -	- 23.5 ^{b, c}	
	T _A = 125 °C	1	- 13.6 ^{b, c}	A
Pulsed Drain Current	Pulsed Drain Current			
Continuous Course Dusin Biode Courset	T _C = 25 °C		- 110	
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	- 9 ^{b, c}	
Avalanche Current	L = 0.1 mH	I _{AS}	- 75	
Single-Pulse Avalanche Energy	L = U.1 IIII	E _{AS}	281	mJ
	T _C = 25 °C		375	
Manianum Danian Disabahan	T _C = 125 °C		125	14/
Maximum Power Dissipation	T _A = 25 °C	P_{D}	13.6 ^{b, c}	W
	T _A = 125 °C		4.5 ^{b, c}	
Operating Junction and Storage Temperature Rai	T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R_{thJA}	8	11	°CAM		
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	0.33	0.4	°C/W		

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under steady state conditions is 40 °C/W.

Document Number: 73471 S12-3071-Rev. C, 24-Dec-12 For technical questions, contact: pmostechsupport@vishay.com

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SPECIFICATIONS ($T_A = 25 ^{\circ}C$, Parameter	Symbol	Test Conditions	Min.	Tvn	Max.	Unit	
Static	Зупион	rest conditions	IVIII I.	Тур.	IVIAX.	Offic	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V, } I_{D} = -250 \mu\text{A}$	- 80			V	
V _{DS} Temperature Coefficient	ΔV _{DS} /T _J	V _{GS} = 0 V, I _D = 200 μ.V	- 00	- 85		· ·	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = - 1 μA		- 5.5		mV/°C	
Gate-Source Threshold Voltage	` '	V _{DS} = V _{GS} , I _D = - 250 μA	- 1	- 5.5	- 3	V	
	V _{GS(th)}	$V_{DS} = V_{GS}, V_{DS} = -250 \mu\text{A}$ $V_{DS} = 0 \text{V}, V_{GS} = \pm 20 \text{V}$	- 1		_	•	
Gate-Source Leakage	I _{GSS}				± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -80 V, V _{GS} = 0 V			- 1 μA		
-		V _{DS} = -80 V, V _{GS} = 0 V, T _J = 175 °C			- 500	00 .	
On-State Drain Current ^a	I _{D(on)}	V _{DS} ≥ 10 V, V _{GS} = - 10 V	- 120			Α	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 10 V, I _D = - 20 A		0.0093	0.0112	Ω	
Brain Course on Clare Needlands	DO(OII)	V _{GS} = - 4.5 V, I _D = - 15 A		0.0120	0.0145		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 20 A		85		S	
Dynamic ^b							
Input Capacitance	C _{iss}			10850		pF	
Output Capacitance	C _{oss}	$V_{DS} = -40 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		800			
Reverse Transfer Capacitance	C _{rss}]		700			
Tatal Oats Observe	Qg	V _{DS} = - 40 V, V _{GS} = - 10 V, I _D = - 110 A		180	270)	
Total Gate Charge				85	130	nC	
Gate-Source Charge	Q _{gs}	V _{DS} = - 40 V, V _{GS} = - 4.5 V, I _D = - 110 A		35			
Gate-Drain Charge	Q_{gd}]		42			
Gate Resistance	R _g	f = 1 MHz		3.6		Ω	
Turn-On Delay Time	t _{d(on)}			20	30		
Rise Time	t _r	V _{DD} = - 40 V, R _I = 0.36 Ω		330	500	ns	
Turn-Off Delay Time	t _{d(off)}	$I_{D} \approx -110 \text{ A}, V_{GEN} = -10 \text{ V}, R_{q} = 1 \Omega$		135	205		
Fall Time	t _f			550	825		
Drain-Source Body Diode Characteristics							
Continuous Source-Drain Diode Current	Is	T _C = 25 °C			- 110	А	
Pulse Diode Forward Current ^a	I _{SM}	-			- 120		
Body Diode Voltage	V _{SD}	I _S = - 20 A		- 0.8	- 1.5	V	
Body Diode Reverse Recovery Time	t _{rr}	, , ,		65	100	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	1		135	205	nC	
Reverse Recovery Fall Time	t _a	$I_F = -20 \text{ A, di/dt} = 100 \text{ A/µs, T}_J = 25 ^{\circ}\text{C}$		43	200	ns	
Reverse Recovery Rise Time	t _b	-		22	-		

Notes:

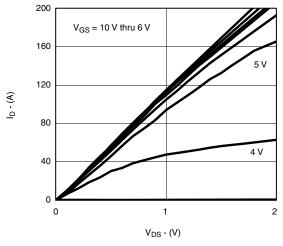
- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

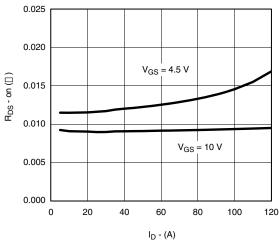


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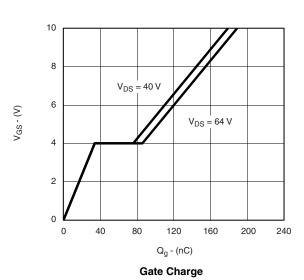
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

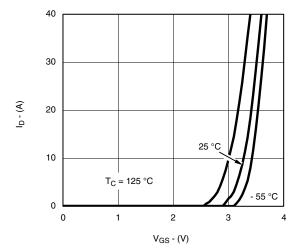


Output Characteristics

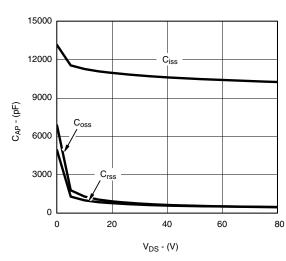


On-Resistance vs. Drain Current

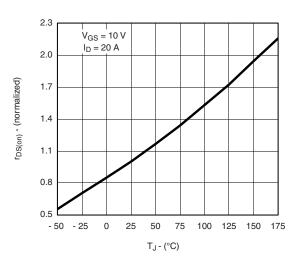




Transfer Characteristics



Capacitance



On-Resistance vs. Junction Temperature

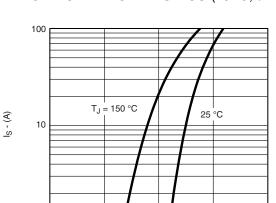
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0

0.3

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

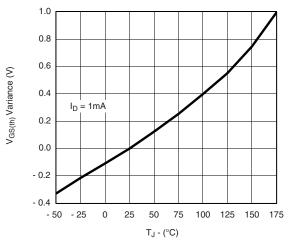


V_{SD} - (V) Source-Drain Diode Forward Voltage

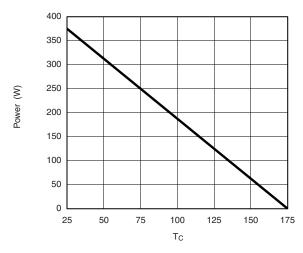
0.6

0.9

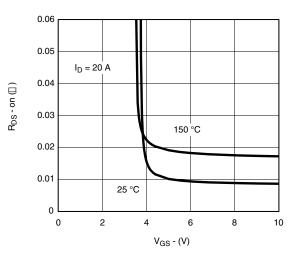
1.2



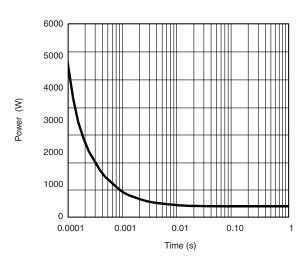
Threshold Voltage



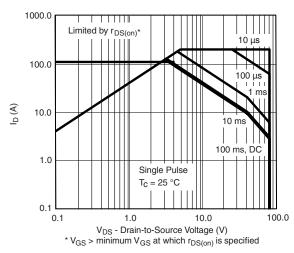
Power Derating, Junction-to-Case



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Case (T_C = 25 °C)

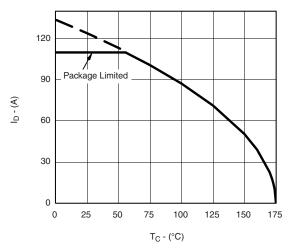


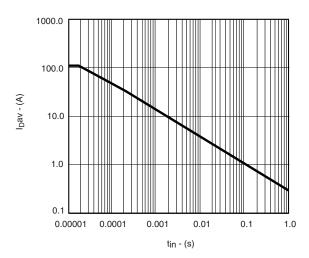
Safe Operating Area



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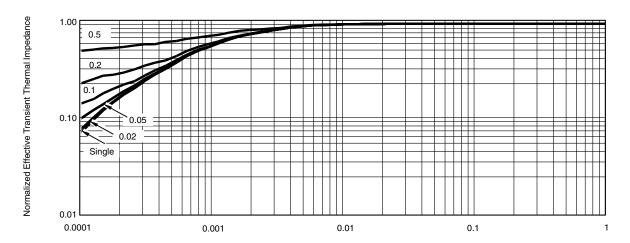
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





Max. Avalanche and Drain Current vs. Case Temperature

Avalanche Current vs. Time

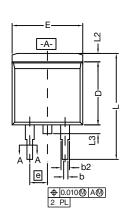


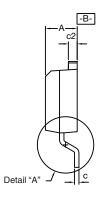
Normalized Thermal Transient Impedance, Junction-to-Case

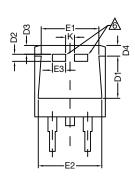
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TO-263 (D²PAK): 3-LEAD

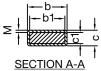








DETAIL A (ROTATED 90°)



_ - b1 , , ,	
≥ 	- -

- 1. Plane B includes maximum features of heat sink tab and plastic.
- 2. No more than 25 % of L1 can fall above seating plane by max. 8 mils.
- 3. Pin-to-pin coplanarity max. 4 mils.
- 4. *: Thin lead is for SUB, SYB. Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

6. This feature is for thick lead.

		INC	HES	MILLIMETERS		
DIM.		MIN.	MAX.	MIN.	MAX.	
Α		0.160	0.190	4.064	4.826	
b		0.020	0.039	0.508	0.990	
	b1	0.020	0.035	0.508	0.889	
	b2	0.045	0.055	1.143	1.397	
c*	Thin lead	0.013	0.018	0.330	0.457	
C	Thick lead	0.023	0.028	0.584	0.711	
c1	Thin lead	0.013	0.017	0.330	0.431	
CI	Thick lead	0.023	0.027	0.584	0.685	
	c2	0.045	0.055	1.143	1.397	
	D	0.340	0.380	8.636	9.652	
	D1	0.220	0.240	5.588	6.096	
D2		0.038	0.042	0.965	1.067	
D3		0.045	0.055	1.143	1.397	
D4		0.044	0.052	1.118	1.321	
E		0.380	0.410	9.652	10.414	
E1		0.245	-	6.223	=	
E2		0.355	0.375	9.017	9.525	
E3		0.072	0.078	1.829	1.981	
е		0.100) BSC	2.54 BSC		
K		0.045	0.055	1.143	1.397	
L		0.575	0.625	14.605	15.875	
L1		0.090	0.110	2.286	2.794	
L2		0.040	0.055	1.016	1.397	
L3		0.050	0.070	1.270	1.778	
L4		0.010 BSC		0.254 BSC		
M		-	0.002	-	0.050	
ECN: T13-0707-Rev. K, 30-Sep-13						

DWG: 5843





RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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